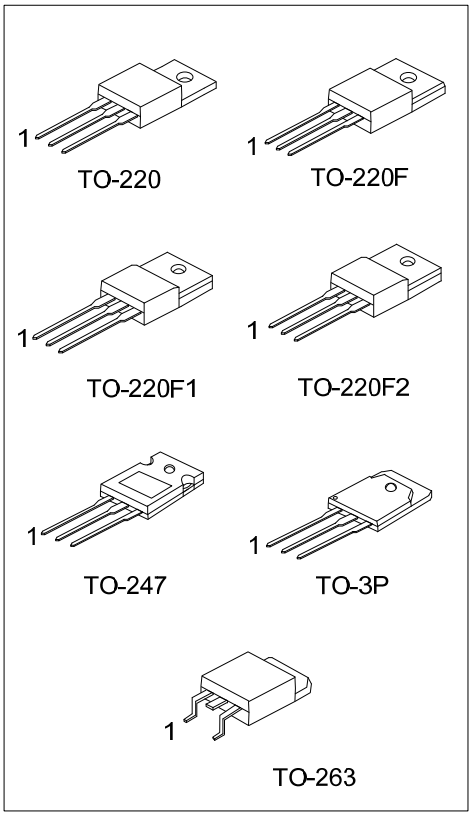
10N80-FC

Power MOSFET

10A, 800V N-CHANNEL POWER MOSFET



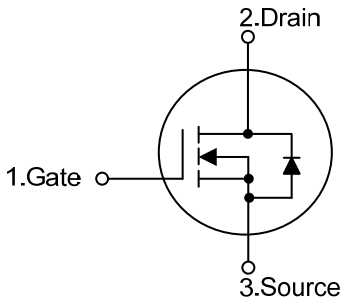
■ DESCRIPTION

The UTC **10N80-FC** provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

■ FEATURES

* $R_{DS(ON)} \leq 0.95\ \Omega$ @ V_{GS}=10V, I_D=5.0A
* Fast switching capability
* Avalanche energy specified

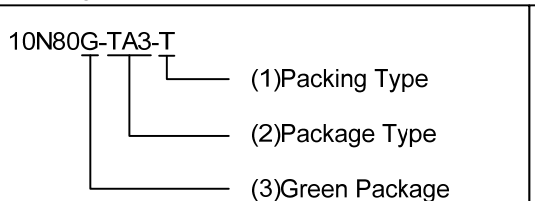
■ SYMBOL



■ ORDERING INFORMATION

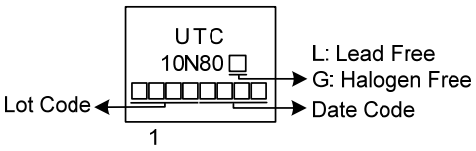
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
10N80L-TA3-T	10N80G-TA3-T	TO-220	G	D	S	Tube
10N80L-TF1-T	10N80G-TF1-T	TO-220F1	G	D	S	Tube
10N80L-TF2-T	10N80G-TF2-T	TO-220F2	G	D	S	Tube
10N80L-TF3-T	10N80G-TF3-T	TO-220F	G	D	S	Tube
10N80L-TQ2-T	10N80G-TQ2-T	TO-263	G	D	S	Tube
10N80L-TQ2-R	10N80G-TQ2-R	TO-263	G	D	S	Tape Reel
10N80L-T47-T	10N80G-T47-T	TO-247	G	D	S	Tube
10N80L-T3P-T	10N80G-T3P-T	TO-3P	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source



(1) T: Tube, R: Tape Reel
(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TQ2: TO-263, T3P: TO-3P, T47: TO-247
(3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	800	V
Gate-Source Voltage		V_{GSS}	±30	V
Continuous Drain Current		I_D	10	A
Pulsed Drain Current (Note 2)		I_{DM}	20	A
Avalanche Energy (Note 3)	Single Pulsed	E_{AS}	433	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.2	V/ns
Power Dissipation (T_A=25°C)	TO-220/TO-263	P_D	145	W
	TO-220F/TO-220F1 TO-220F2		38	W
	TO-247		240	W
	TO-3P		295	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. L=30mH, I_{AS}=5.37A, V_{DD}=50V, R_G=25 Ω, Starting T_J = 25°C
4. I_{SD} ≤ 10A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

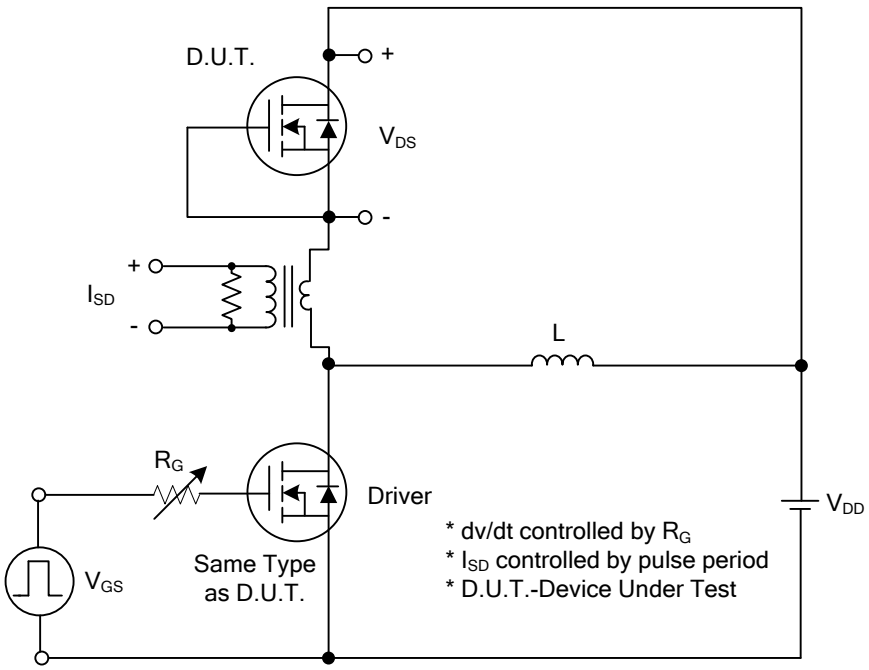
PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-263	θ_{JA}	62.5	°C/W
	TO-247		50	°C/W
	TO-3P		40	°C/W
Junction to Case	TO-220/TO-263	θ_{JC}	0.86	°C/W
	TO-220F/TO-220F1 TO-220F2		3.28	°C/W
	TO-247		0.52	°C/W
	TO-3P		0.42	°C/W

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

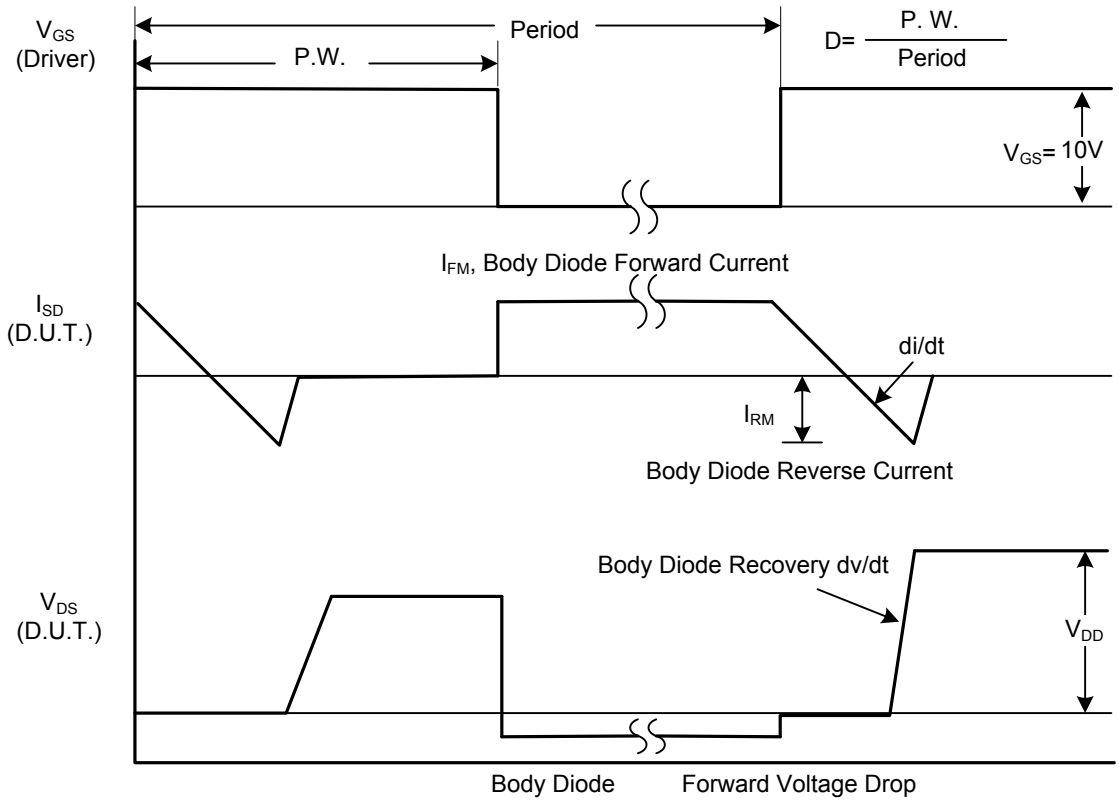
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS}=0V, I_D=250μA	800			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=800V, V_{GS}=0V			10	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS}=30V, V_{DS}=0V			100	nA
	Reverse		V_{GS}=-30V, V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	3.0		5.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=5.0A			0.95	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C_{ISS}	V_{DS} =25V, V_{GS} =0V, f =1MHz		1973		pF
Output Capacitance		C_{OSS}			178		pF
Reverse Transfer Capacitance		C_{RSS}			1.4		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge		Q_G	V_{DS}=640V, V_{GS}=10V, I_D=10A, I_G=1mA (Note 1, 2)		34		nC
Gate-Source Charge		Q_{GS}			12		nC
Gate-Drain Charge		Q_{GD}			5		nC
Turn-On Delay Time		$t_{D\ (ON)}$	V_{DD} =100V, V_{GS}=10V, I_D =10A, R_G=25Ω (Note 1, 2)		25		ns
Turn-On Rise Time		t_R			17.5		ns
Turn-Off Delay Time		$t_{D(OFF)}$			78		ns
Turn-Off Fall Time		t_F			39		ns
DRAIN-SOURCE DIODE CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				10	A
Continuous Drain-Source Current		I_{SD}				20	A
Drain-Source Diode Forward Voltage		V_{SD}	I_S=10A, V_{GS}=0V			1.4	V
Reverse Recovery Time		t_{rr}	I_F=10A, di/dt = 100A/μs		534		ns
Reverse Recovery Charge		Q_{rr}			7.2		μC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle≤2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

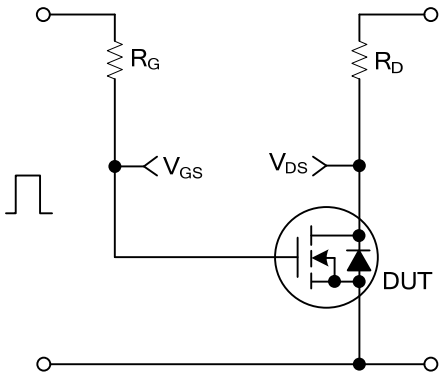


Peak Diode Recovery dv/dt Test Circuit

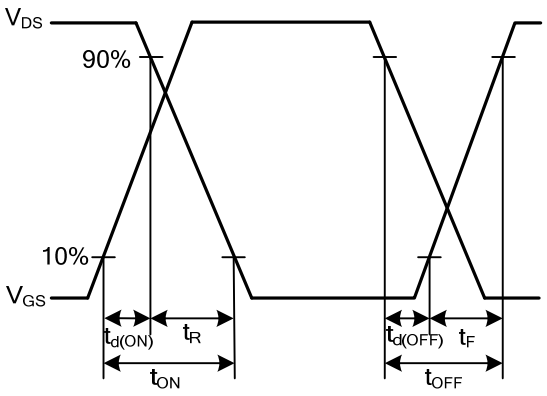


Peak Diode Recovery dv/dt Waveforms

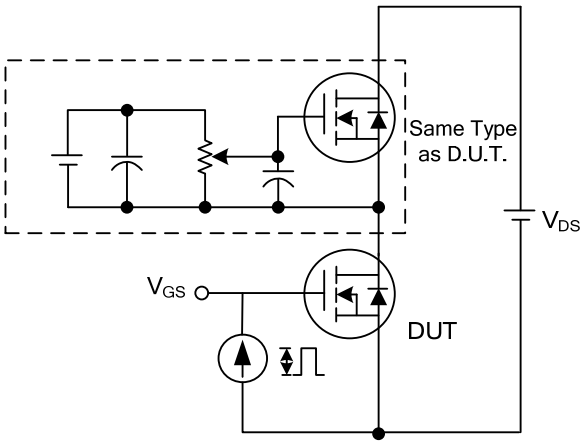
■ TEST CIRCUITS AND WAVEFORMS



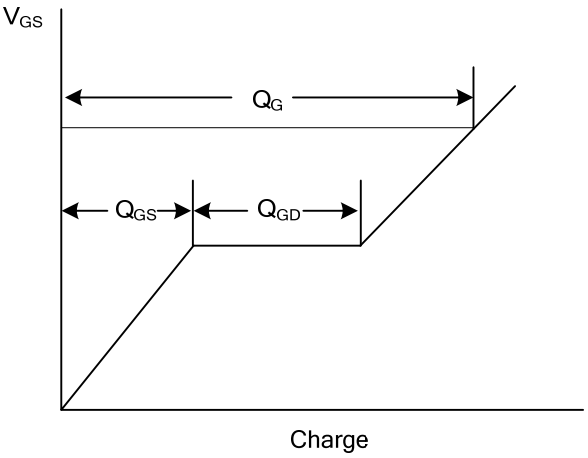
itching Test Circuit



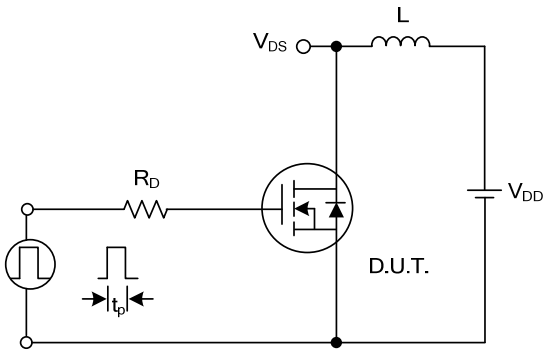
Switching Waveforms



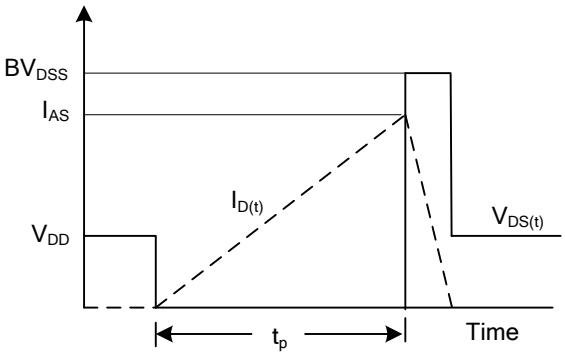
Gate Charge Test Circuit



Gate Charge Waveform



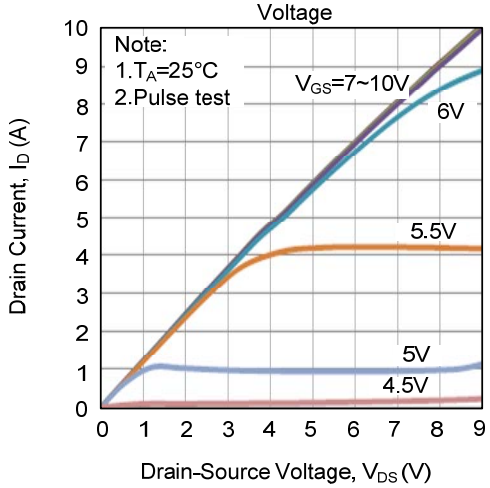
Unclamped Inductive Switching Test Circuit



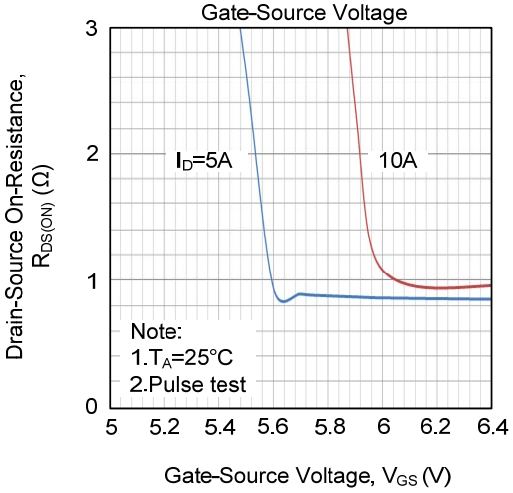
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

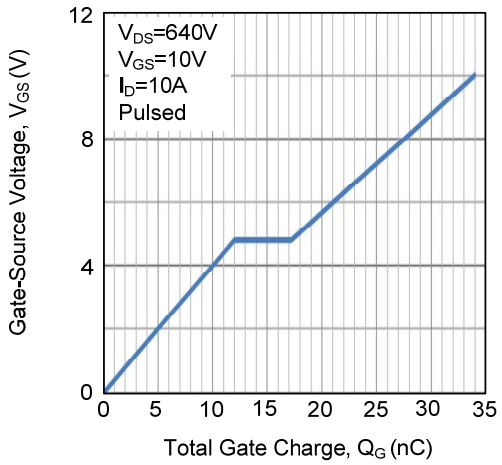
Drain Current vs. Drain-Source Voltage



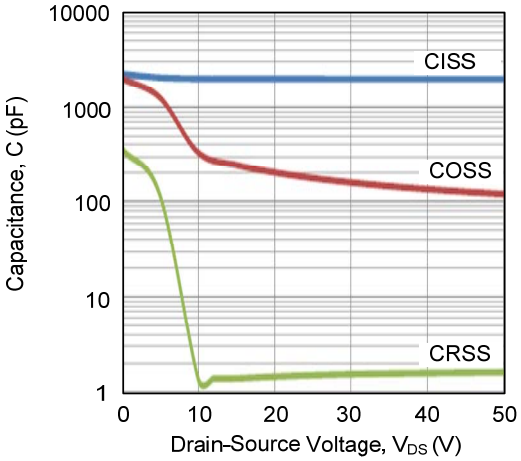
Drain-Source On-Resistance vs. Gate-Source Voltage



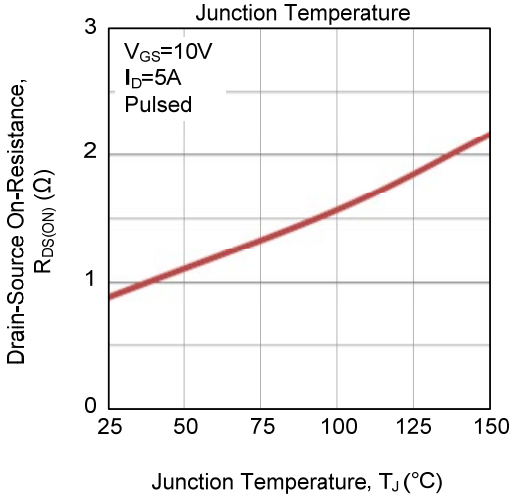
Gate Charge Characteristics



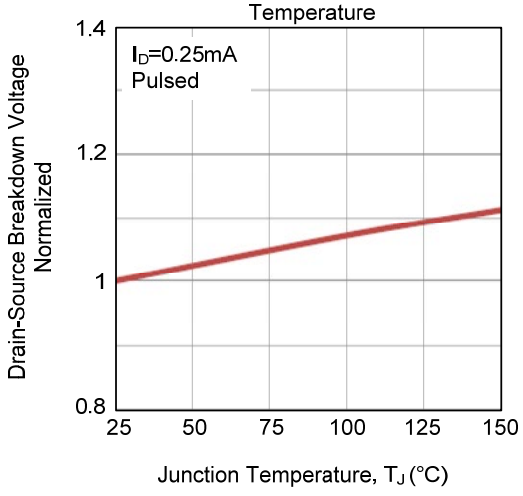
Capacitance Characteristics



Drain-Source On-Resistance vs. Junction Temperature

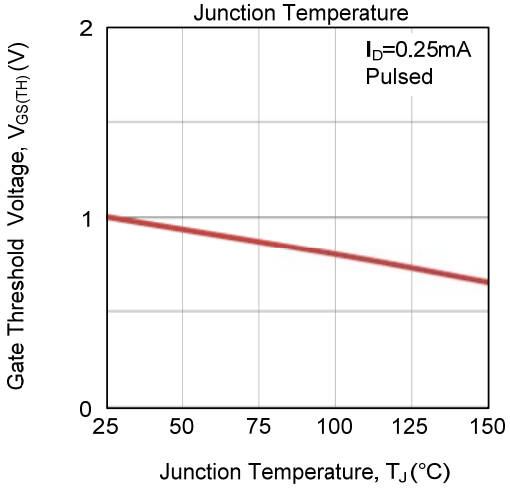


Breakdown Voltage vs. Junction Temperature

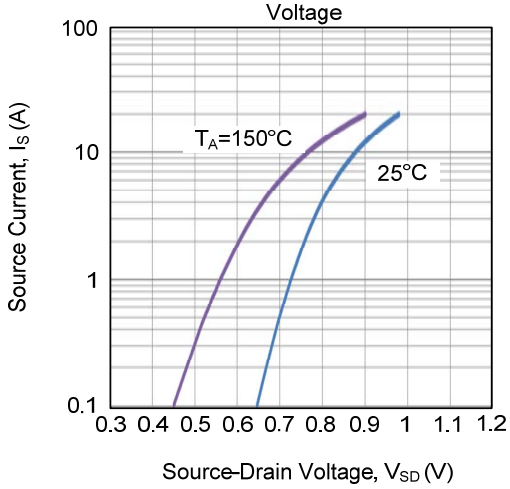


■ TYPICAL CHARACTERISTICS (Cont.)

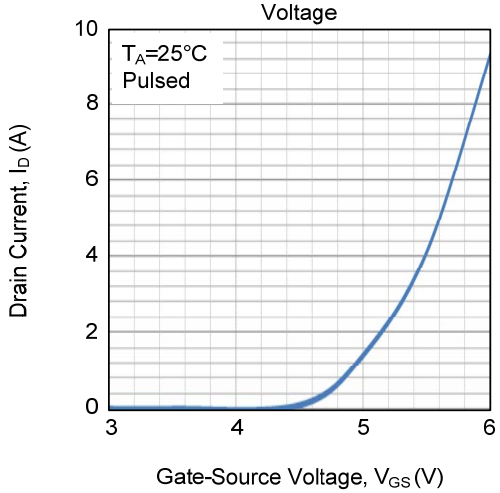
Gate Threshold Voltage vs. Junction Temperature



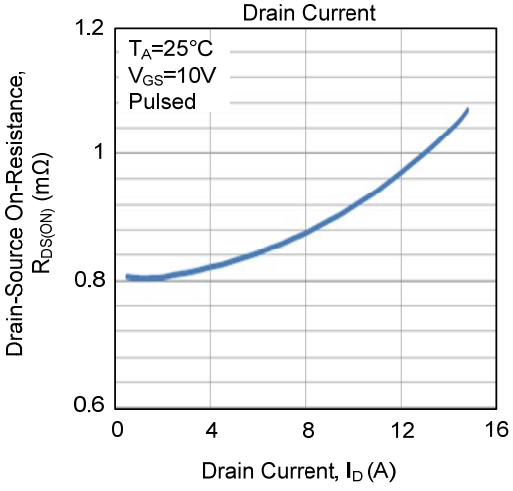
Source Current vs. Source-Drain Voltage



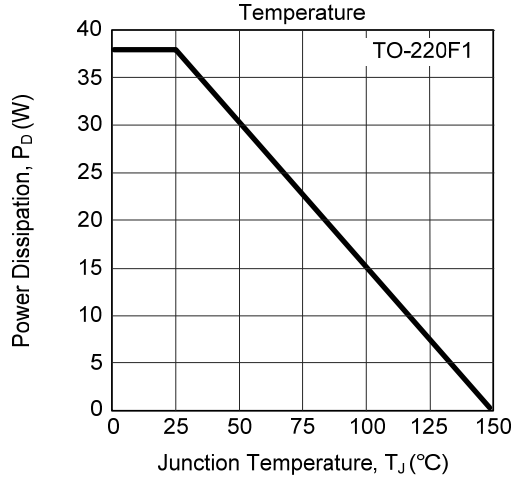
Drain Current vs. Gate-Source Voltage



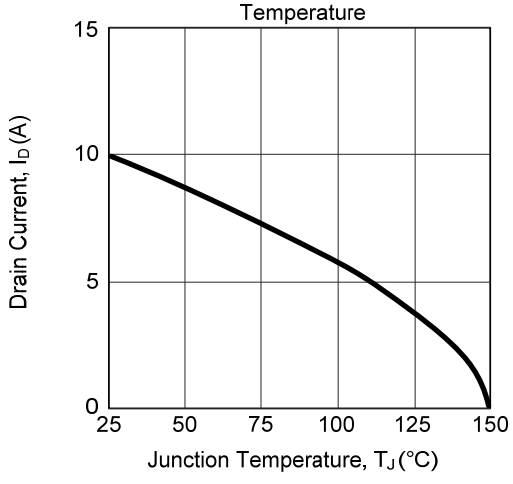
Drain-Source On-Resistance vs. Drain Current



Power Dissipation vs. Junction Temperature



Drain Current vs. Junction Temperature



■ TYPICAL CHARACTERISTICS (Cont.)